# 74LVC1G74

Single D-type flip-flop with set and reset; positive edge trigger

Rev. 07 — 26 June 2008 Product data sheet

## 1. General description

The 74LVC1G74 is a single positive edge triggered D-type flip-flop with individual data (D) inputs, clock (CP) inputs, set  $(\overline{S}D)$  and reset  $(\overline{R}D)$  inputs, and complementary Q and  $\overline{Q}$  outputs.

This device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing damaging backflow current through the device when it is powered down.

The set and reset are asynchronous active LOW inputs and operate independently of the clock input. Information on the data input is transferred to the Q output on the LOW-to-HIGH transition of the clock pulse. The D inputs must be stable one set-up time prior to the LOW-to-HIGH clock transition for predictable operation.

Schmitt trigger action at all inputs makes the circuit highly tolerant of slower input rise and fall times.

#### 2. Features

- Wide supply voltage range from 1.65 V to 5.5 V
- 5 V tolerant inputs for interfacing with 5 V logic
- High noise immunity
- Complies with JEDEC standard:
  - ◆ JESD8-7 (1.65 V to 1.95 V)
  - ◆ JESD8-5 (2.3 V to 2.7 V)
  - ◆ JESD8-B/JESD36 (2.7 V to 3.6 V)
- ±24 mA output drive (V<sub>CC</sub> = 3.0 V)
- ESD protection:
  - ◆ HBM JESD22-A114E exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Inputs accept voltages up to 5 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



### Single D-type flip-flop with set and reset; positive edge trigger

# 3. Ordering information

Table 1. Ordering information

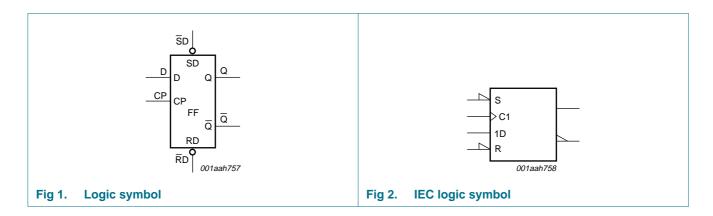
Type number	Package							
	Temperature range	Name	Description	Version				
74LVC1G74DP	–40 °C to +125 °C	TSSOP8	plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm	SOT505-2				
74LVC1G74DC	–40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads; body width 2.3 mm	SOT765-1				
74LVC1G74GT	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 $\times$ 1.95 $\times$ 0.5 mm	SOT833-1				
74LVC1G74GD	–40 °C to +125 °C	XSON8U	plastic extremely thin small outline package; no leads; 8 terminals; UTLP based; body $3\times2\times0.5$ mm	SOT996-2				
74LVC1G74GM	–40 °C to +125 °C	XQFN8U	plastic extremely thin quad flat package; no leads; 8 terminals; UTLP based; body $1.6\times1.6\times0.5$ mm	SOT902-1				

# 4. Marking

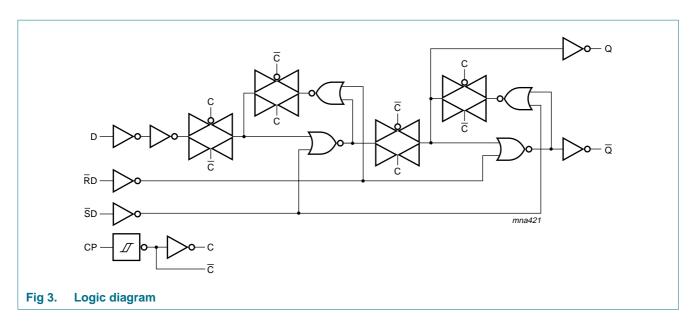
Table 2. Marking codes

Type number	Marking code
74LVC1G74DP	V74
74LVC1G74DC	V74
74LVC1G74GT	V74
74LVC1G74GD	V74
74LVC1G74GM	V74

# 5. Functional diagram

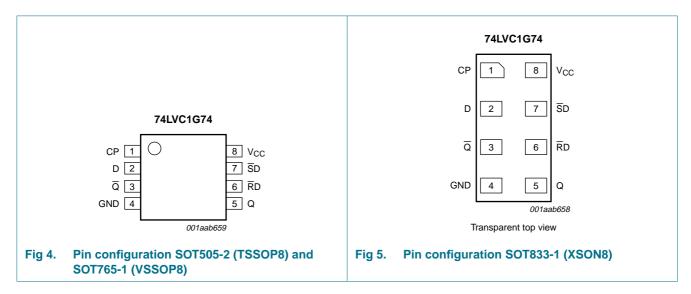


### Single D-type flip-flop with set and reset; positive edge trigger

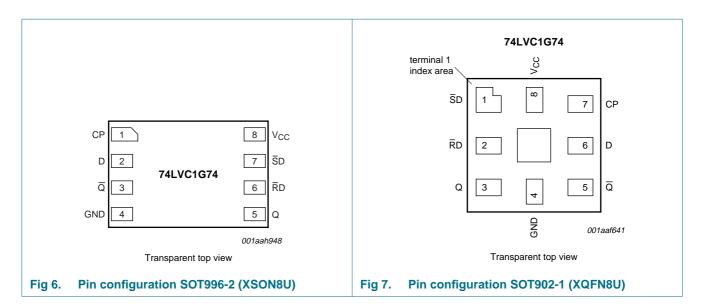


# 6. Pinning information

## 6.1 Pinning



## Single D-type flip-flop with set and reset; positive edge trigger



# 6.2 Pin description

Table 3. Pin description

Symbol	Pin		Description
	SOT505-2, SOT765-1, SOT833-1 and SOT996-2	SOT902-1	
CP	1	7	clock input (LOW-to-HIGH, edge-triggered)
D	2	6	data input
Q	3	5	complement output
GND	4	4	ground (0 V)
Q	5	3	true output
RD	6	2	asynchronous reset-direct input (active LOW)
SD	7	1	asynchronous set-direct input (active LOW)
V <sub>CC</sub>	8	8	supply voltage

# 7. Functional description

Table 4. Function table for asynchronous operation[1]

Input				Output		
SD	RD	СР	D	Q	Q	
L	Н	X	X	Н	L	
Н	L	X	X	L	Н	
L	L	Χ	Χ	Н	Н	

<sup>[1]</sup> H = HIGH voltage level;

L = LOW voltage level;

X = don't care.

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Table 5. Function table for synchronous operation[1]

Input		Output			
SD	RD	СР	D	Q <sub>n+1</sub>	$\overline{Q}_{n+1}$
Н	Н	$\uparrow$	L	L	Н
Н	Н	$\uparrow$	Н	Н	L

<sup>[1]</sup> H = HIGH voltage level;

L = LOW voltage level;

↑ = LOW-to-HIGH CP transition;

 $Q_{n+1}$  = state after the next LOW-to-HIGH CP transition.

## 8. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
l <sub>OK</sub>	output clamping current	$V_O > V_{CC}$ or $V_O < 0$ V	-	±50	mA
Vo	output voltage	Active mode	<u>[1]</u> –0.5	$V_{CC} + 0.5$	V
		Power-down mode	[1][2] -0.5	+6.5	V
lo	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	<u>[3]</u> _	300	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

# 9. Recommended operating conditions

Table 7. Operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		1.65	5.5	V
VI	input voltage		0	5.5	V
Vo	output voltage	Active mode	0	$V_{CC}$	V
		Power-down mode; $V_{CC} = 0 \text{ V}$	0	5.5	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 1.65 \text{ V to } 2.7 \text{ V}$	-	20	ns/V
		$V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$	-	10	ns/V

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<sup>[2]</sup> When  $V_{CC} = 0 \text{ V}$  (Power-down mode), the output voltage can be 5.5 V in normal operation.

<sup>[3]</sup> For TSSOP8 packages: above 55 °C the value of P<sub>tot</sub> derates linearly with 2.5 mW/K.
For VSSOP8 packages: above 110 °C the value of P<sub>tot</sub> derates linearly with 8.0 mW/K.
For XSON8, XSON8U and XQFN8U packages: above 45 °C the value of P<sub>tot</sub> derates linearly with 2.4 mW/K.

### Single D-type flip-flop with set and reset; positive edge trigger

# 10. Static characteristics

Table 8. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
T <sub>amb</sub> = -	40 °C to +85 °C					
$V_{IH}$	HIGH-level input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	$0.7 \times V_{CC}$	-	-	V
$V_{IL}$	LOW-level input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	$0.3 \times V_{CC}$	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_O = -100 \mu\text{A};  V_{CC} = 1.65  \text{V}  \text{to}  5.5  \text{V}$	$V_{CC} - 0.1$	-	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	1.54	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.9	2.15	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	2.50	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.3	2.62	-	V
		$I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.8	4.11	-	V
$V_{OL}$	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_O$ = 100 $\mu$ A; $V_{CC}$ = 1.65 V to 5.5 V	-	-	0.10	V
		$I_O = 4 \text{ mA}$ ; $V_{CC} = 1.65 \text{ V}$	-	0.07	0.45	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	0.12	0.30	V
		$I_{O}$ = 12 mA; $V_{CC}$ = 2.7 V	-	0.17	0.40	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	0.33	0.55	V
		$I_{O} = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.39	0.55	V
I <sub>I</sub>	input leakage current	$V_I = 5.5 \text{ V or GND};$ $V_{CC} = 0 \text{ V to } 5.5 \text{ V}$	-	±0.1	±5	μΑ
I <sub>OFF</sub>	power-off leakage current	$V_I$ or $V_O = 5.5$ V; $V_{CC} = 0$ V	-	±0.1	±10	μΑ
I <sub>CC</sub>	supply current	$V_I = 5.5 \text{ V or GND};$ $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}; I_O = 0 \text{ A}$	-	0.1	10	μΑ
$\Delta I_{CC}$	additional supply current	per pin; $V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A};$ $V_{CC} = 2.3 \text{ V}$ to 5.5 V	-	5	500	μΑ
C <sub>I</sub>	input capacitance		-	4.0	-	pF

# Single D-type flip-flop with set and reset; positive edge trigger

**Table 8. Static characteristics** ...continued
At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Uni
Γ <sub>amb</sub> = −	40 °C to +125 °C					
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	$0.7 \times V_{CC}$	-	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	$0.3 \times V_{CC}$	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_{O} = -100 \mu\text{A};  V_{CC} = 1.65 \text{V} \text{ to } 5.5 \text{V}$	$V_{CC} - 0.1$	-	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	0.95	-	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.7	-	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	1.9	-	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.0	-	-	V
		$I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.4	-	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_{O}$ = 100 $\mu$ A; $V_{CC}$ = 1.65 V to 5.5 V	-	-	0.10	V
		$I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.70	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.45	V
		$I_{O} = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.60	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.80	V
		$I_{O} = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.80	V
l <sub>l</sub>	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	-	±20	μΑ
OFF	power-off leakage current	$V_I$ or $V_O = 5.5$ V; $V_{CC} = 0$ V	-	-	±20	μΑ
lcc	supply current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 1.65 V to 5.5 V; I <sub>O</sub> = 0 A	-	-	40	μΑ
Δl <sub>CC</sub>	additional supply current	per pin; $V_I = V_{CC} - 0.6 \text{ V}$ ; $I_O = 0 \text{ A}$ ; $V_{CC} = 2.3 \text{ V}$ to 5.5 V	-	-	5000	μΑ

<sup>[1]</sup> All typical values are measured at  $T_{amb}$  = 25 °C.

# Single D-type flip-flop with set and reset; positive edge trigger

# 11. Dynamic characteristics

Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 10.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	–40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t <sub>pd</sub> propagation dela		CP to Q, Q; see Figure 8	[2]				1	'	•
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	6.0	13.4	1.5	13.4	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	3.5	7.1	1.0	7.1	ns
		$V_{CC} = 2.7 \text{ V}$		1.0	3.5	7.1	1.0	7.1	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	3.5	5.9	1.0	5.9	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		1.0	2.5	4.1	1.0	4.1	ns
		$\overline{S}D$ to Q, $\overline{Q}$ ; see Figure 9	[2]						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	6.0	12.9	1.5	12.9	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	3.5	7.0	1.0	7.0	ns
		$V_{CC} = 2.7 \text{ V}$		1.0	3.5	7.0	1.0	7.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	3.0	5.9	1.0	5.9	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		1.0	2.5	4.1	1.0	4.1	ns
		$\overline{R}D$ to Q, $\overline{Q}$ ; see Figure 9	[2]						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	5.0	12.9	1.5	12.9	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	3.5	7.0	1.0	7.0	ns
		$V_{CC} = 2.7 \text{ V}$		1.0	3.5	7.0	1.0	7.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	3.0	5.9	1.0	5.9	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		1.0	2.5	4.1	1.0	4.1	ns
t <sub>W</sub>	pulse width	CP HIGH or LOW; see Figure 8							
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		6.2	-	-	6.2	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		2.7	-	-	2.7	-	ns
		$V_{CC} = 2.7 \text{ V}$		2.7	-	-	2.7	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		2.7	1.3	-	2.7	-	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		2.0	-	-	2.0	-	ns
		SD and RD LOW; see Figure 9							
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		6.2	-	-	6.2	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2.7	-	-	2.7	-	ns
		$V_{CC} = 2.7 \text{ V}$		2.7	-	-	2.7	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		2.7	1.6	-	2.7	-	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		2.0	-	-	2.0	-	ns

#### Single D-type flip-flop with set and reset; positive edge trigger

 Table 9.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 10.

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	-40 °C t	o +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
t <sub>rec</sub>	recovery time	SD or RD; see Figure 9					'	•
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	1.9	-	-	1.9	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.4	-	-	1.4	-	ns
		$V_{CC} = 2.7 \text{ V}$	1.3	-	-	1.3	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	+1.2	-3.0	-	+1.2	-	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	1.0	-	-	1.0	-	ns
t <sub>su</sub>	set-up time	D to CP; see Figure 8						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	2.9	-	-	2.9	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7	-	-	1.7	-	ns
		$V_{CC} = 2.7 \text{ V}$	1.7	-	-	1.7	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.3	0.5	-	1.3	-	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	1.1	-	-	1.1	-	ns
t <sub>h</sub>	hold time	D to CP; see Figure 8						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	1.5	-	-	1.5	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.0	-	-	1.0	-	ns
		$V_{CC} = 2.7 \text{ V}$	1.0	-	-	1.0	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.0	0.6	-	1.0	-	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	1.0	-	-	1.0	-	ns
f <sub>max</sub>	maximum	CP; see Figure 8						
	frequency	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	80	-	-	80	-	MHz
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	175	-	-	175	-	MHz
		$V_{CC} = 2.7 \text{ V}$	175	-	-	175	-	MHz
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	175	280	-	175	-	MHz
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	200	-	-	200	-	MHz
$C_{PD}$	power dissipation capacitance	$V_I = GND \text{ to } V_{CC};$ $V_{CC} = 3.3 \text{ V}$	[3]	15	-	-	-	pF

<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.8 V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o) \text{ where:}$ 

 $f_i$  = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

 $C_L$  = output load capacitance in pF;

 $V_{CC}$  = supply voltage in V;

N = number of inputs switching;

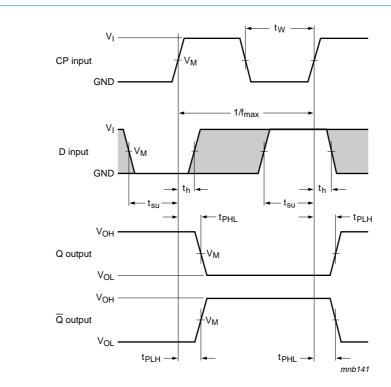
 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.

<sup>[2]</sup> t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.

<sup>[3]</sup>  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W).

# Single D-type flip-flop with set and reset; positive edge trigger

#### 12. Waveforms



Measurement points are given in Table 10.

The shaded areas indicate when the input is permitted to change for predictable output performance.

V<sub>OL</sub> and V<sub>OH</sub> are typical output voltage levels that occur with the output load.

Fig 8. The clock input (CP) to output  $(Q, \overline{Q})$  propagation delays, the clock pulse width, the D to CP set-up, the CP to D hold times and the maximum frequency

Table 10. Measurement points

Supply voltage	Input	Output
V <sub>CC</sub>	V <sub>M</sub>	V <sub>M</sub>
1.65 V to 1.95 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
2.3 V to 2.7 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
2.7 V	1.5 V	1.5 V
3.0 V to 3.6 V	1.5 V	1.5 V
4.5 V to 5.5 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$

# Single D-type flip-flop with set and reset; positive edge trigger

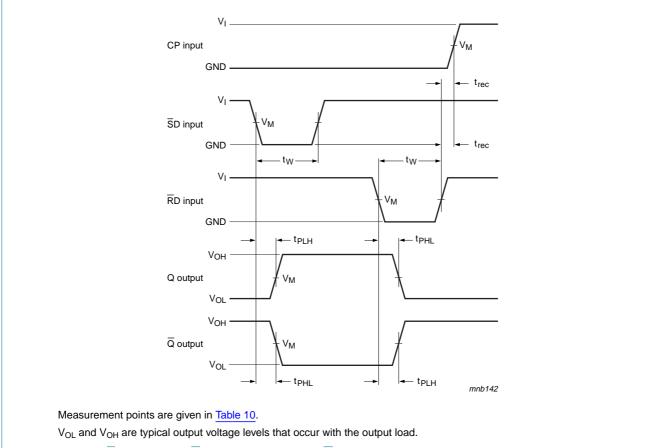
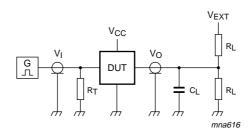


Fig 9. The set  $(\overline{SD})$  and reset  $(\overline{RD})$  input to output  $(Q, \overline{Q})$  propagation delays, the set and reset pulse widths and the  $\overline{RD}$  to CP recovery time

### Single D-type flip-flop with set and reset; positive edge trigger



Test data is given in Table 11.

Definitions for test circuit:

 $R_L$  = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to the output impedance  $Z_0$  of the pulse generator.

 $V_{EXT}$  = External voltage for measuring switching times.

Fig 10. Test circuit for measuring switching times

Table 11. Test data

Supply voltage	Input		Load		V <sub>EXT</sub>			
V <sub>CC</sub>	VI	t <sub>r</sub> , t <sub>f</sub>	CL	R <sub>L</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>	
1.65 V to 1.95 V	$V_{CC}$	≤ 2.0 ns	30 pF	1 kΩ	open	GND	2V <sub>CC</sub>	
2.3 V to 2.7 V	$V_{CC}$	≤ 2.0 ns	30 pF	$500 \Omega$	open	GND	2V <sub>CC</sub>	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	$500 \Omega$	open	GND	6 V	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	GND	6 V	
4.5 V to 5.5 V	$V_{CC}$	≤ 2.5 ns	50 pF	500 Ω	open	GND	2V <sub>CC</sub>	

### Single D-type flip-flop with set and reset; positive edge trigger

# 13. Package outline

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm SOT505-2

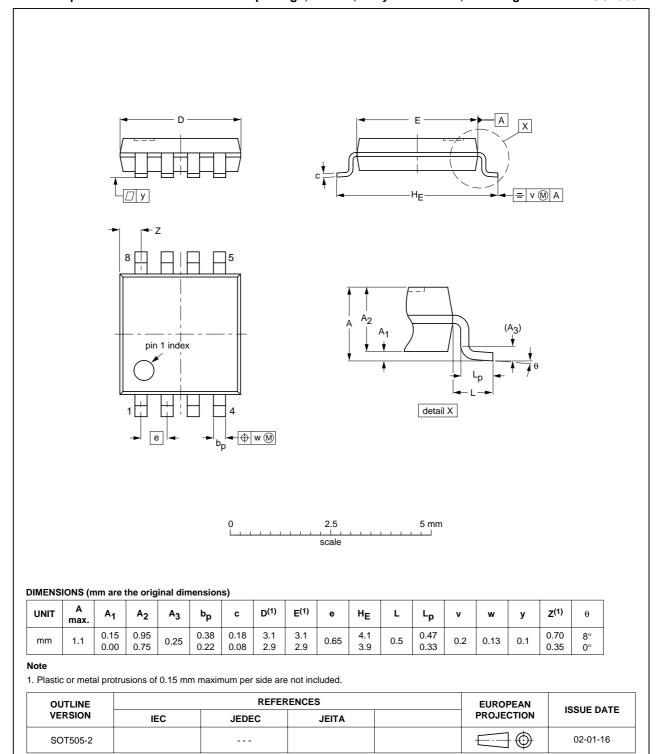


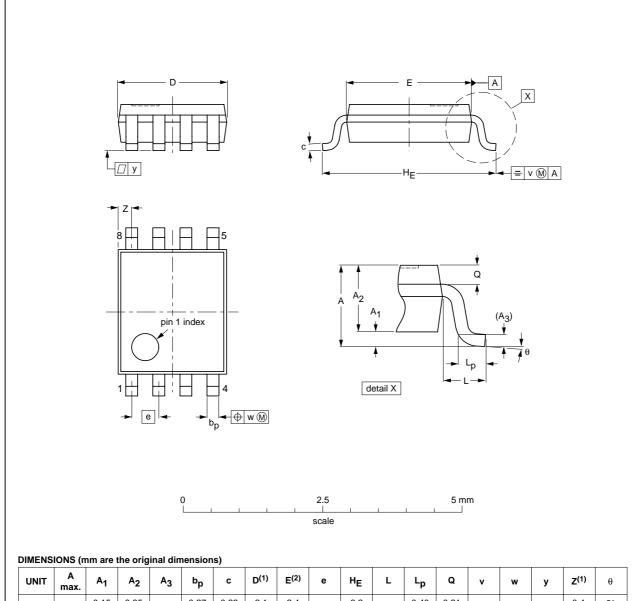
Fig 11. Package outline SOT505-2 (TSSOP8)

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#### Single D-type flip-flop with set and reset; positive edge trigger

#### VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm

SOT765-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1	0.15 0.00	0.85 0.60	0.12	0.27 0.17	0.23 0.08	2.1 1.9	2.4 2.2	0.5	3.2 3.0	0.4	0.40 0.15	0.21 0.19	0.2	0.13	0.1	0.4 0.1	8° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	1330E DATE
SOT765-1		MO-187				02-06-07

Fig 12. Package outline SOT765-1 (VSSOP8)

#### Single D-type flip-flop with set and reset; positive edge trigger

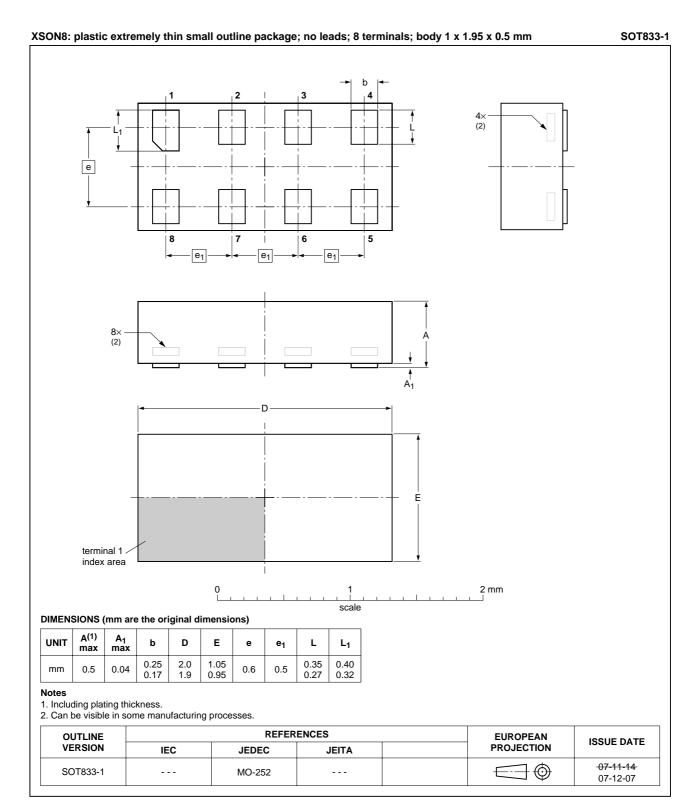


Fig 13. Package outline SOT833-1 (XSON8)

#### Single D-type flip-flop with set and reset; positive edge trigger

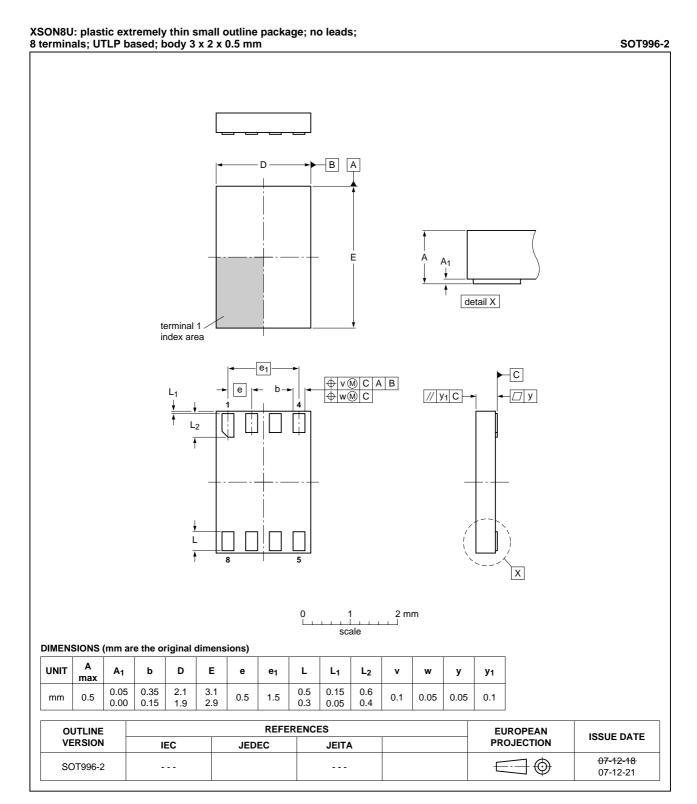


Fig 14. Package outline SOT996-2 (XSON8U)

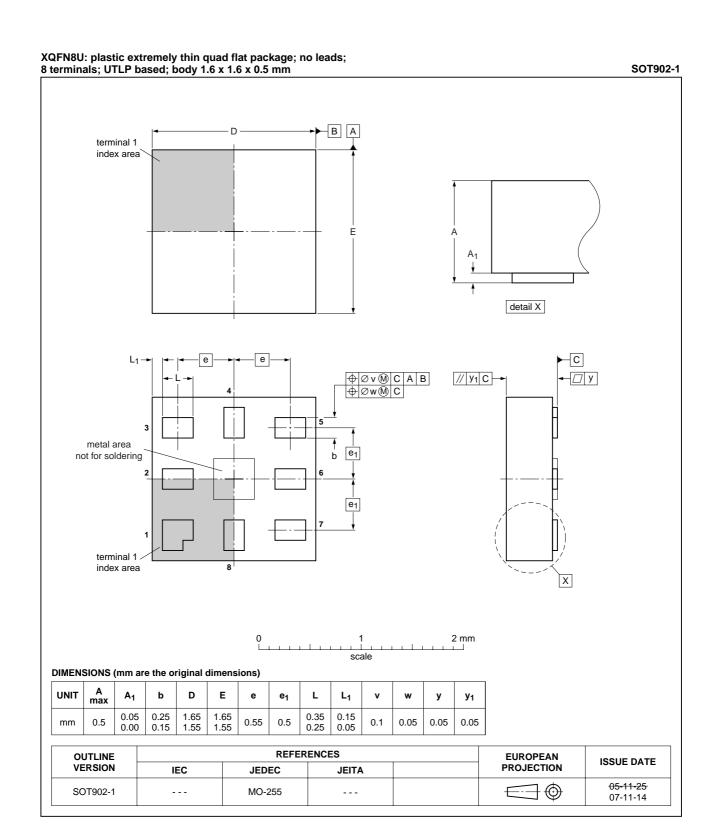


Fig 15. Package outline SOT902-1 (XQFN8U)

# Single D-type flip-flop with set and reset; positive edge trigger

# 14. Abbreviations

#### Table 12. Abbreviations

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
TTL	Transistor-Transistor Logic
НВМ	Human Body Model
ESD	ElectroStatic Discharge
MM	Machine Model
DUT	Device Under Test

# 15. Revision history

#### Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC1G74_7	20080626	Product data sheet	-	74LVC1G74_6
Modifications:	<ul> <li>Added type</li> </ul>	number 74LVC1G74GD (XSO	N8U package)	
74LVC1G74_6	20080219	Product data sheet	-	74LVC1G74_5
74LVC1G74_5	20070809	Product data sheet	-	74LVC1G74_4
74LVC1G74_4	20061207	Product data sheet	-	74LVC1G74_3
74LVC1G74_3	20050201	Product specification	-	74LVC1G74_2
74LVC1G74_2	20040909	Product specification	-	74LVC1G74_1
74LVC1G74_1	20040202	Product specification	-	-

#### Single D-type flip-flop with set and reset; positive edge trigger

# 16. Legal information

#### 16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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### Single D-type flip-flop with set and reset; positive edge trigger

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